



VN770K

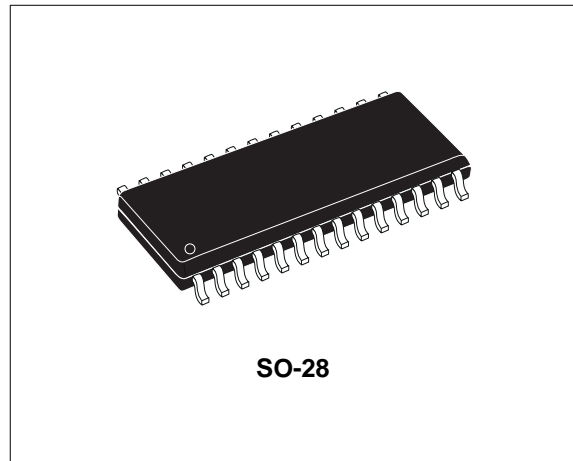
QUAD SMART POWER SOLID STATE RELAY FOR COMPLETE H BRIDGE CONFIGURATIONS

TYPE	R _{DS(on)}	I _{OUT}	V _{CC}
VN770K	220mΩ (*)	9A (**)	36V

(*) Total resistance of one side in bridge configuration

(**) Typical current limitation value

- SUITED AS LOW VOLTAGE BRIDGE
- LINEAR CURRENT LIMITATION
- VERY LOW STAND-BY POWER DISSIPATION
- SHORT CIRCUIT PROTECTED
- STATUS FLAG DIAGNOSTIC (OPEN DRAIN)
- INTEGRATED CLAMPING CIRCUITS
- UNDERVOLTAGE PROTECTION
- ESD PROTECTION



DESCRIPTION

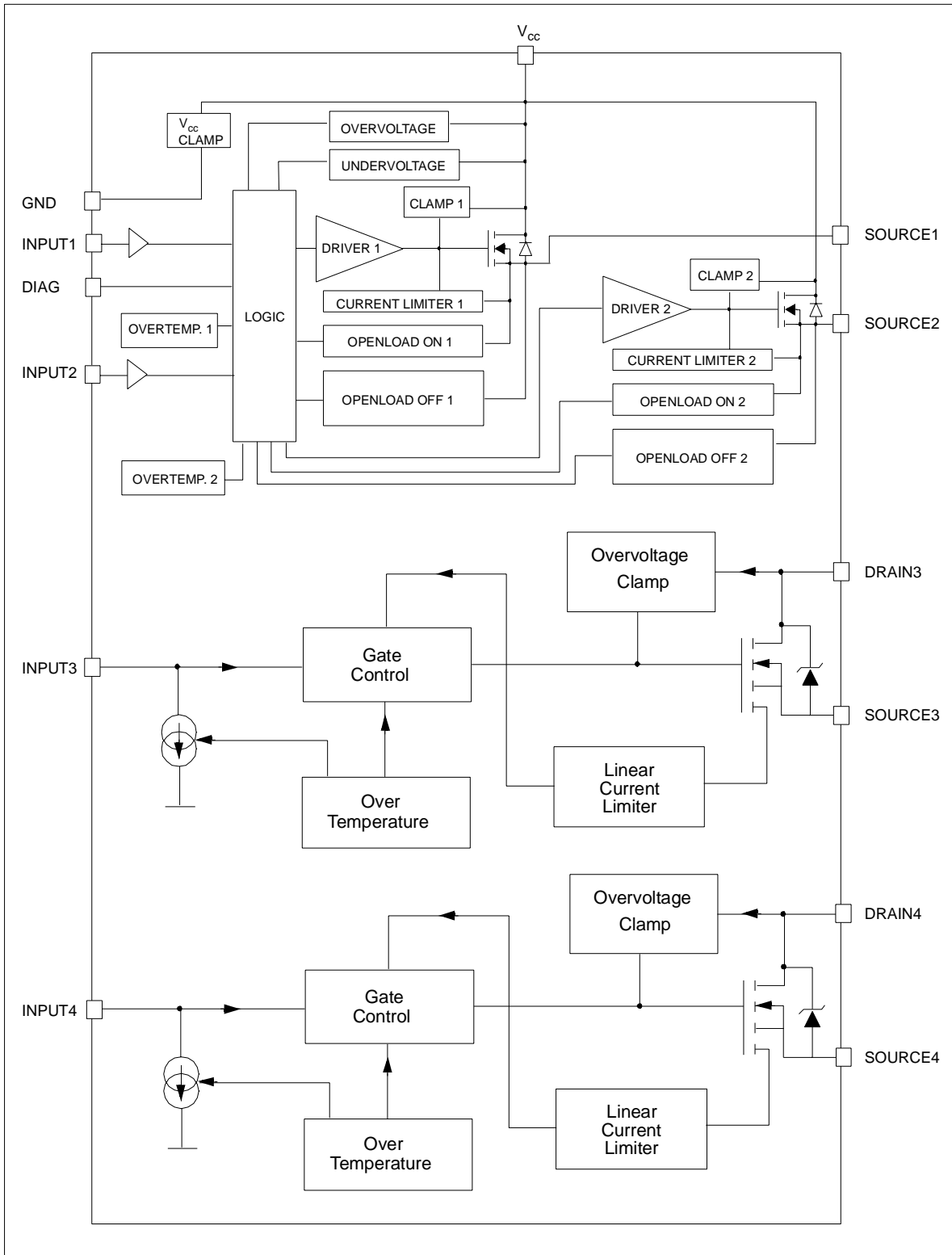
The VN770K is a device formed by three monolithic chips housed in a standard SO-28 package: a double high side and two low side switches. Both the double high side and low side switches are made using STMicroelectronics VIPower™ M0-3 Technology. This device is suitable to drive a DC motor in a bridge configuration as well as to be used as a quad switch for any low voltage application. The dual high side switches have built-in thermal shutdown

to protect the chips from overtemperature and current limiter blocks to protect the device from short circuit. Status output is provided to indicate open load in off and on state and overtemperature. The low side switches are two OMNIFET II types (fully autoprotected Power MOSFET in VIPower™ technology). They have built-in thermal shutdown, linear current limitation and overvoltage clamping. Fault feedback for thermal intervention can be detected by monitoring the voltage at the input pin.

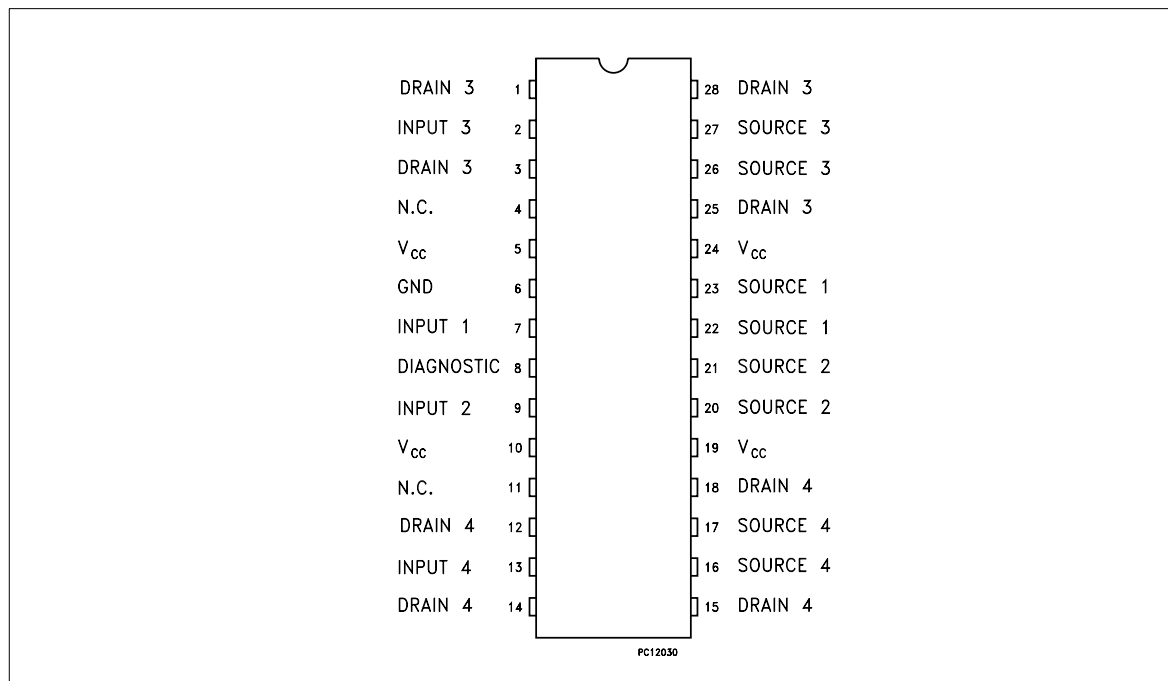
PIN FUNCTION

No	NAME	FUNCTION
1, 3, 25, 28	DRAIN 3	Drain of Switch 3 (low-side switch)
2	INPUT 3	Input of Switch 3 (low-side switch)
4, 11	N.C.	Not Connected
5, 10, 19, 24	V _{CC}	Drain of Switches 1 and 2 (high-side switches) and Power Supply Voltage
6	GND	Ground of Switches 1 and 2 (high-side switches)
7	INPUT 1	Input of Switch 1 (high-side switches)
8	DIAGNOSTIC	Diagnostic of Switches 1 and 2 (high-side switches)
9	INPUT 2	Input of Switch 2 (high-side switch)
12, 14, 15, 18	DRAIN 4	Drain of switch 4 (low-side switch)
13	INPUT 4	Input of Switch 4 (low-side switch)
16, 17	SOURCE 4	Source of Switch 4 (low-side switch)
20, 21	SOURCE 2	Source of Switch 2 (high-side switch)
22, 23	SOURCE 1	Source of Switch 1 (high-side switch)
26, 27	SOURCE 3	Source of Switch 3 (low-side switch)

BLOCK DIAGRAM



CONNECTION DIAGRAM



THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal Resistance Junction-case (High-side switch)	MAX	20 °C/W
$R_{thj-case}$	Thermal Resistance Junction-case (Low-side switch)	MAX	20 °C/W
$R_{thj-amb}$	Thermal Resistance Junction-ambient	MAX	60 °C/W

ABSOLUTE MAXIMUM RATING

DUAL HIGH SIDE SWITCH

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	41	V
$-V_{CC}$	Reverse DC Supply Voltage	- 0.3	V
$-I_{GND}$	DC Reverse Ground Pin Current	- 200	mA
I_{OUT}	DC Output Current	Internally Limited	A
$-I_{OUT}$	Reverse DC Output Current	- 6	A
I_{IN}	DC Input Current	+/- 10	mA
I_{stat}	DC Status Current	+/- 10	mA
V_{ESD}	Electrostatic Discharge (Human Body Model: R=1.5K Ω ; C=100pF)		
	- INPUT	4000	V
	- STATUS	4000	V
	- OUTPUT	5000	V
	- V_{CC}	5000	V
P_{tot}	Power Dissipation ($T_C=25^\circ\text{C}$)	6	W
T_j	Junction Operating Temperature	Internally Limited	°C
T_C	Case Operating Temperature	- 40 to 150	°C
T_{stg}	Storage Temperature	- 55 to 150	°C

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ABSOLUTE MAXIMUM RATING (continued)

LOW SIDE SWITCH

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage ($V_{IN}=0V$)	Internally Clamped	V
V_{IN}	Input Voltage	Internally Clamped	V
I_{IN}	Input Current	+/-20	mA
$R_{IN\ MIN}$	Minimum Input Series Impedance	150	Ω
I_D	Drain Current	Internally Limited	A
I_R	Reverse DC Output Current	-10.5	A
V_{ESD1}	Electrostatic Discharge ($R=1.5K\Omega$, $C=100pF$)	4000	V
V_{ESD2}	Electrostatic Discharge on output pin only ($R=330\Omega$, $C=150pF$)	16500	V
P_{tot}	Power Dissipation ($T_C=25^\circ C$)	6	W
T_j	Operating Junction Temperature	Internally limited	$^\circ C$
T_c	Case Operating Temperature	Internally limited	$^\circ C$
T_{stg}	Storage Temperature	-55 to 150	$^\circ C$

ELECTRICAL CHARACTERISTICS FOR DUAL HIGH SIDE SWITCH

($8V < V_{CC} < 36V$; $-40^\circ C < T_j < 150^\circ C$, unless otherwise specified)

POWER OUTPUTS (Per each channel)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{CC}^{(**)}$	Operating Supply Voltage		5.5	13	36	V
$V_{USD}^{(**)}$	Undervoltage Shut-down		3	4	5.5	V
$V_{OV}^{(**)}$	Overvoltage Shut-down		36			V
R_{ON}	On State Resistance	$I_{OUT}=1A$; $T_j=25^\circ C$			160	$m\Omega$
		$I_{OUT}=1A$; $V_{CC}>8V$			320	$m\Omega$
$I_S^{(**)}$	Supply Current	Off State; $V_{CC}=13V$; $V_{IN}=V_{OUT}=0V$		12	40	μA
		Off State; $V_{CC}=13V$; $V_{IN}=V_{OUT}=0V$; $T_j=25^\circ C$		12	25	μA
		On State; $V_{CC}=13V$; $V_{IN}=5V$; $I_{OUT}=0A$		5	7	mA
$I_{L(off1)}$	Off State Output Current	$V_{IN}=V_{OUT}=0V$	0		50	μA
$I_{L(off2)}$	Off State Output Current	$V_{IN}=0V$; $V_{OUT}=3.5V$	-75		0	μA
$I_{L(off3)}$	Off State Output Current	$V_{IN}=V_{OUT}=0V$; $V_{CC}=13V$; $T_j=125^\circ C$			5	μA
$I_{L(off4)}$	Off State Output Current	$V_{IN}=V_{OUT}=0V$; $V_{CC}=13V$; $T_j=25^\circ C$			3	μA

(**) Per device

SWITCHING ($V_{CC}=13V$)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$t_{d(on)}$	Turn-on Delay Time	$R_L=13\Omega$ from V_{IN} rising edge to $V_{OUT}=1.3V$		30		μs
$t_{d(off)}$	Turn-off Delay Time	$R_L=13\Omega$ from V_{IN} falling edge to $V_{OUT}=11.7V$		30		μs
$\frac{dV_{OUT}}{dt_{(on)}}$	Turn-on Voltage Slope	$R_L=13\Omega$ from $V_{OUT}=1.3V$ to $V_{OUT}=10.4V$		See relative diagram		$V/\mu s$
$\frac{dV_{OUT}}{dt_{(off)}}$	Turn-off Voltage Slope	$R_L=13\Omega$ from $V_{OUT}=11.7V$ to $V_{OUT}=1.3V$		See relative diagram		$V/\mu s$

ELECTRICAL CHARACTERISTICS FOR DUAL HIGH SIDE SWITCH (continued)

LOGIC INPUT

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{IL}	Input Low Level				1.25	V
I_{IL}	Low Level Input Current	$V_{IN} = 1.25V$	1			μA
V_{IH}	Input High Level		3.25			V
I_{IH}	High Level Input Current	$V_{IN} = 3.25V$			10	μA
V_{hyst}	Input Hysteresis Voltage		0.5			V
V_{ICL}	Input Clamp Voltage	$I_{IN} = 1mA$	6	6.8	8	V
		$I_{IN} = -1mA$		-0.7		V

STATUS PIN

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{STAT}	Status Low Output Voltage	$I_{STAT} = 1.6 mA$			0.5	V
I_{LSTAT}	Status Leakage Current	Normal Operation; $V_{STAT} = 5V$			10	μA
C_{STAT}	Status Pin Input Capacitance	Normal Operation; $V_{STAT} = 5V$			100	pF
V_{SCL}	Status Clamp Voltage	$I_{STAT} = 1mA$	6	6.8	8	V
		$I_{STAT} = -1mA$		-0.7		V

PROTECTIONS

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
T_{TSD}	Shut-down Temperature		150	175	200	$^{\circ}C$
T_R	Reset Temperature		135			$^{\circ}C$
T_{hyst}	Thermal Hysteresis		7	15		$^{\circ}C$
t_{sdl}	Status Delay in Overload Conditions	$T_j > T_{TSD}$			20	μs
I_{lim}	Current limitation	$T_j = 125^{\circ}C$ $5.5V < V_{CC} < 36V$	7	10	13	A
			8		13	A
					13	A
V_{demag}	Turn-off Output Clamp Voltage	$I_{OUT} = 1A; L = 6mH$	$V_{CC} - 41$	$V_{CC} - 48$	$V_{CC} - 55$	V

OPENLOAD DETECTION

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_{OL}	Openload ON State Detection Threshold	$V_{IN} = 5V$	20	40	80	mA
$t_{DOL(on)}$	Openload ON State Detection Delay	$I_{OUT} = 0A$			200	μs
V_{OL}	Openload OFF State Voltage Detection Threshold	$V_{IN} = 0V$	1.5	2.5	3.5	V
$t_{DOL(off)}$	Openload Detection Delay at Turn Off				1000	μs

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ELECTRICAL CHARACTERISTICS FOR LOW SIDE SWITCHES

($-40^{\circ}\text{C} < T_j < 150^{\circ}\text{C}$, unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{CLAMP}	Drain-source Clamp Voltage	$V_{\text{IN}}=0\text{V}; I_{\text{D}}=3.5\text{A}$	40	45	55	V
V_{CLTH}	Drain-source Clamp Threshold Voltage	$V_{\text{IN}}=0\text{V}; I_{\text{D}}=2\text{mA}$	36			V
V_{INTH}	Input Threshold Voltage	$V_{\text{DS}}=V_{\text{IN}}; I_{\text{D}}=1\text{mA}$	0.5		2.5	V
I_{ISS}	Supply Current from Input Pin	$V_{\text{DS}}=0\text{V}; V_{\text{IN}}=5\text{V}$		100	150	μA
V_{INCL}	Input-Source Clamp Voltage	$I_{\text{IN}}=1\text{mA}$ $I_{\text{IN}}=-1\text{mA}$	6 -1.0	6.8	8 -0.3	V
I_{DSS}	Zero Input Voltage Drain Current ($V_{\text{IN}}=0\text{V}$)	$V_{\text{DS}}=13\text{V}; V_{\text{IN}}=0\text{V}; T_j=25^{\circ}\text{C}$ $V_{\text{DS}}=25\text{V}; V_{\text{IN}}=0\text{V}$			30 75	μA

ON

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$R_{\text{DS(on)}}$	Static Drain-source On Resistance	$V_{\text{IN}}=5\text{V}; I_{\text{D}}=3.5\text{A}; T_j=25^{\circ}\text{C}$ $V_{\text{IN}}=5\text{V}; I_{\text{D}}=3.5\text{A}$			60 120	m Ω

($T_j=25^{\circ}\text{C}$, unless otherwise specified)

DYNAMIC

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
g_{fs}^*	Forward Transconductance	$V_{\text{DD}}=13\text{V}; I_{\text{D}}=3.5\text{A}$		9		S
C_{OSS}	Output Capacitance	$V_{\text{DS}}=13\text{V}; f=1\text{MHz}; V_{\text{IN}}=0\text{V}$		220		pF

SWITCHING

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}; I_{\text{D}}=3.5\text{A}$ $V_{\text{gen}}=5\text{V}; R_{\text{gen}}=R_{\text{IN MIN}}=150\Omega$		100	300	ns
t_{r}	Rise Time			470	1500	ns
$t_{\text{d(off)}}$	Turn-off Delay Time			500	1500	ns
t_{f}	Fall Time			350	1000	ns
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}; I_{\text{D}}=3.5\text{A}$ $V_{\text{gen}}=5\text{V}; R_{\text{gen}}=2.2\text{K}\Omega$		0.75	2.3	μs
t_{r}	Rise Time			4.6	14.0	μs
$t_{\text{d(off)}}$	Turn-off Delay Time			5.4	16.0	μs
t_{f}	Fall Time			3.6	11.0	μs
$(\text{dI}/\text{dt})_{\text{on}}$	Turn-on Current Slope	$V_{\text{DD}}=15\text{V}; I_{\text{D}}=3.5\text{A}$ $V_{\text{gen}}=5\text{V}; R_{\text{gen}}=R_{\text{IN MIN}}=150\Omega$		6.5		A/ μs
Q_{i}	Total Input Charge	$V_{\text{DD}}=12\text{V}; I_{\text{D}}=3.5\text{A}; V_{\text{IN}}=5\text{V}$ $I_{\text{gen}}=2.13\text{mA}$		18		nC

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{SD}^*	Forward On Voltage	$I_{\text{SD}}=3.5\text{A}; V_{\text{IN}}=0\text{V}$		0.8		V
t_{rr}	Reverse Recovery Time	$I_{\text{SD}}=3.5\text{A}; \text{dI}/\text{dt}=20\text{A}/\mu\text{s}$ $V_{\text{DD}}=30\text{V}; L=200\mu\text{H}$		220		ns
Q_{rr}	Reverse Recovery Charge			0.28		μC
I_{RRM}	Reverse Recovery Current			2.5		A

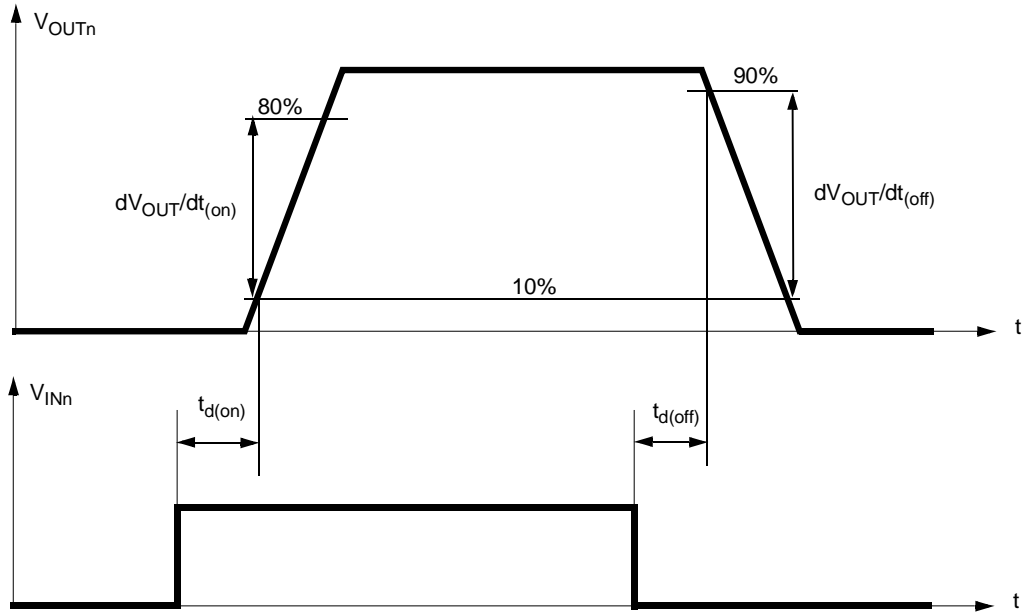
ELECTRICAL CHARACTERISTICS FOR LOW SIDE SWITCHES (continued)
PROTECTIONS ($-40^{\circ}\text{C} < T_j < 150^{\circ}\text{C}$, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_{lim}	Drain Current Limit	$V_{IN}=5\text{V}; V_{DS}=13\text{V}$	6	9	12	A
		$V_{IN}=5\text{V}; V_{DS}=13\text{V}; T_j=125^{\circ}\text{C}$	6.5		12	A
t_{dlim}	Step Response Current Limit	$V_{IN}=5\text{V}; V_{DS}=13\text{V}$		4.0		μs
T_{jsh}	Overtemperature Shutdown		150	175		$^{\circ}\text{C}$
T_{jrs}	Overtemperature Reset		135			$^{\circ}\text{C}$
I_{gf}	Fault Sink Current	$V_{IN}=5\text{V}; V_{DS}=13\text{V}; T_j=T_{jsh}$		15		mA
E_{as}	Single Pulse	starting $T_j=25^{\circ}\text{C}; V_{DD}=24\text{V}$				
	Avalanche Energy	$V_{IN}=5\text{V}; R_{gen}=R_{IN\text{ MIN}}=150\Omega; L=24\text{mH}$	200			mJ

(*) Pulsed: Pulse duration = 300 μs , duty cycle 1.5%

DUAL HIGH-SIDE SWITCH

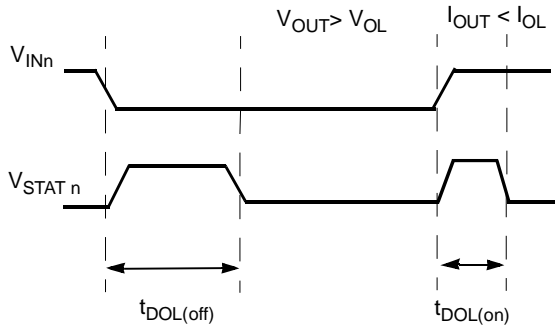
SWITCHING TIME WAVEFORMS



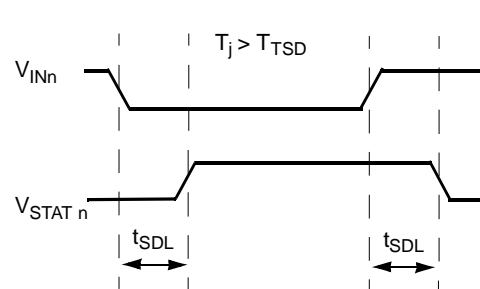
TRUTH TABLE

CONDITIONS	INPUT	OUTPUT	STATUS
Normal Operation	L	L	H
	H	H	H
Current Limitation	L	L	H
	H	X	$(T_j < T_{TSD})$ H $(T_j > T_{TSD})$ L
Overtemperature	L	L	H
	H	L	L
Undervoltage	L	L	X
	H	L	X
Overvoltage	L	L	H
	H	L	H
Output Voltage $> V_{OL}$	L	H	L
	H	H	H
Output Current $< I_{OL}$	L	L	H
	H	H	L

OPEN LOAD STATUS TIMING (with external pull-up)



OVER TEMP STATUS TIMING



TYPICAL APPLICATION DIAGRAM

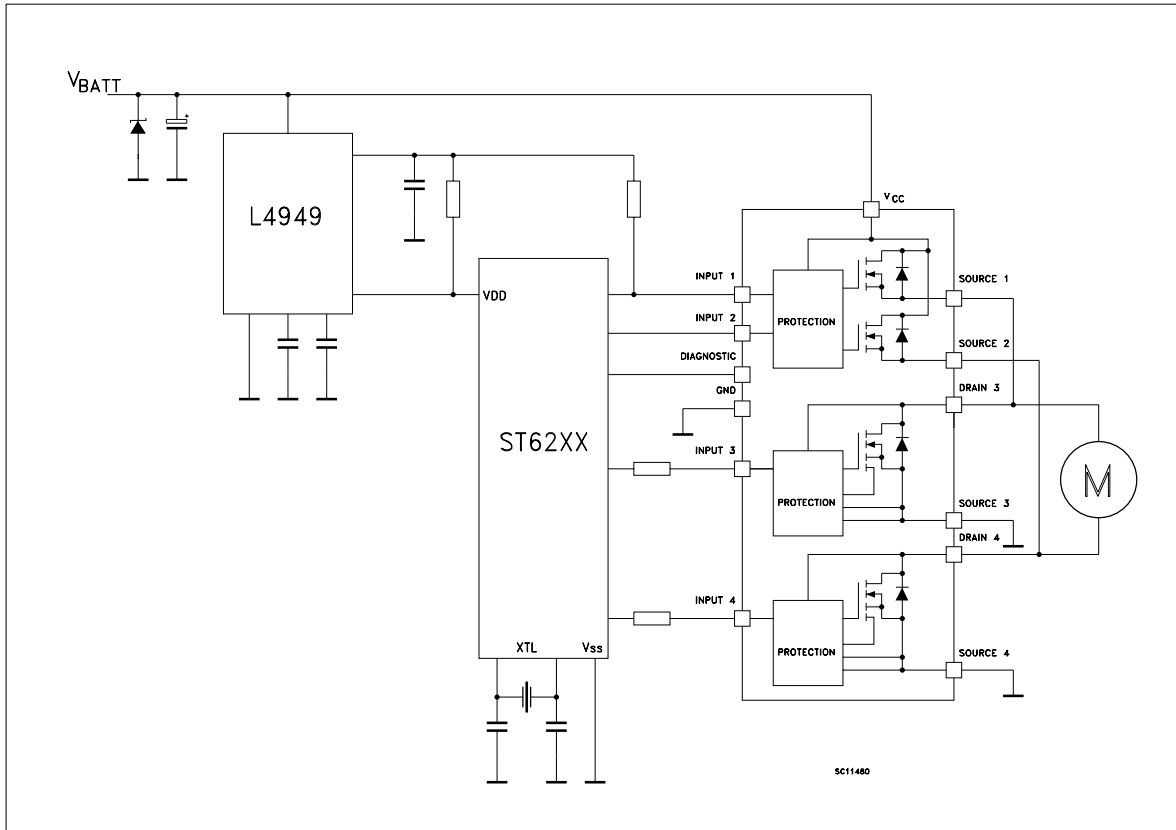
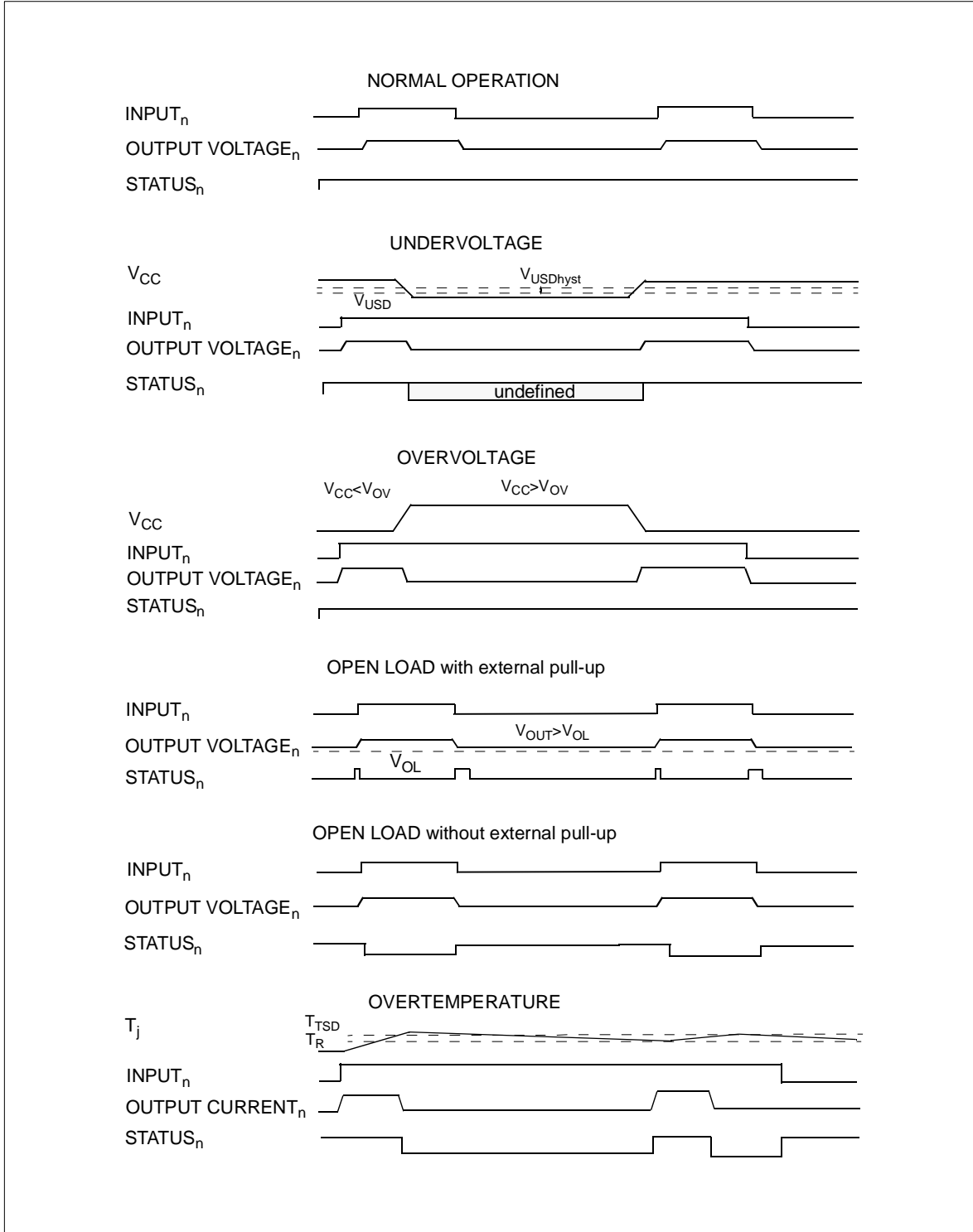
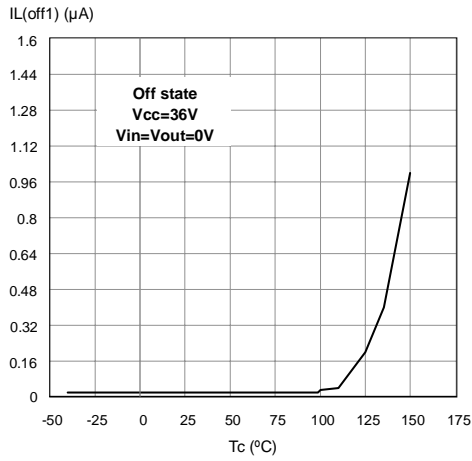


Figure 1: Waveforms

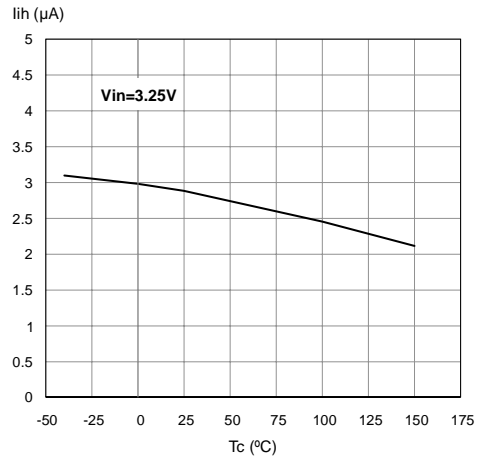


ELECTRICAL CHARACTERIZATION FOR DUAL HIGH SIDE SWITCH

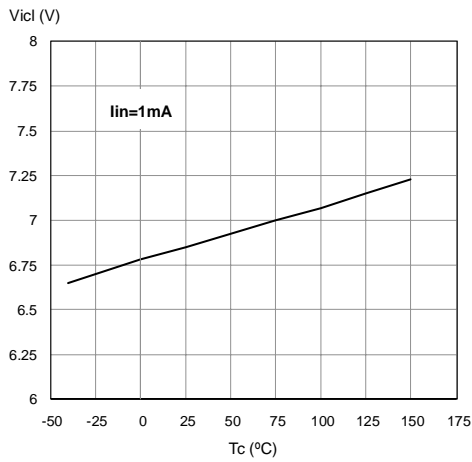
Off State Output Current



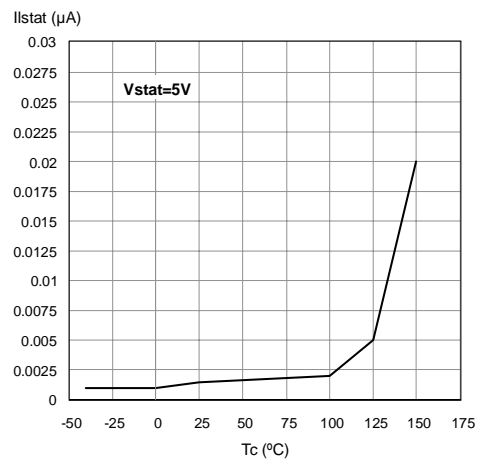
High Level Input Current



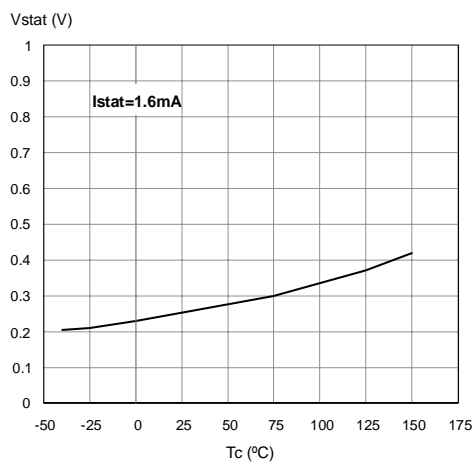
Input Clamp Voltage



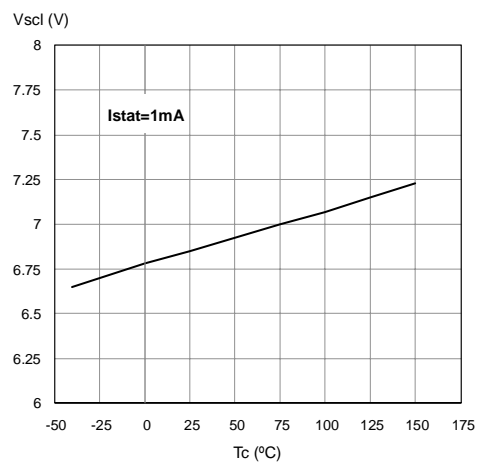
Status Leakage Current



Status Low Output Voltage

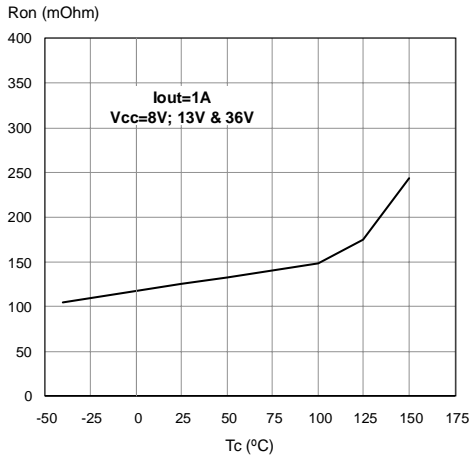


Status Clamp Voltage

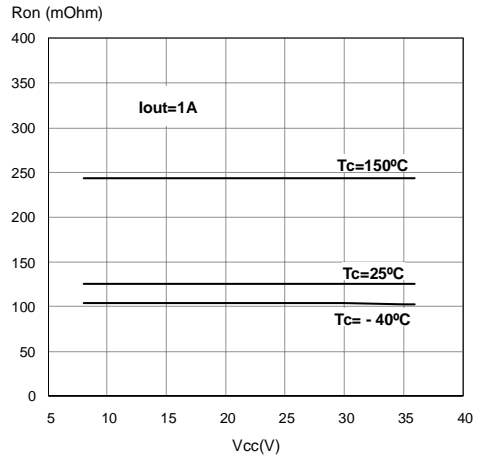


ELECTRICAL CHARACTERIZATION FOR DUAL HIGH SIDE SWITCH (continued)

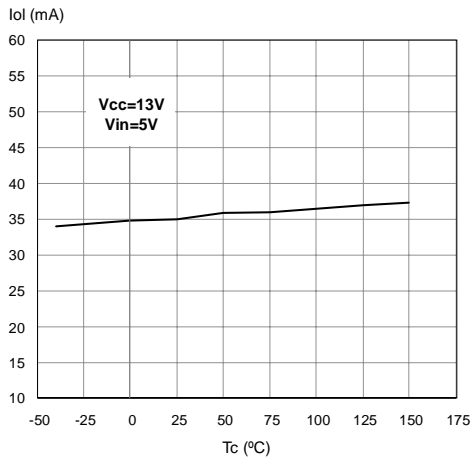
On State Resistance Vs T_{case}



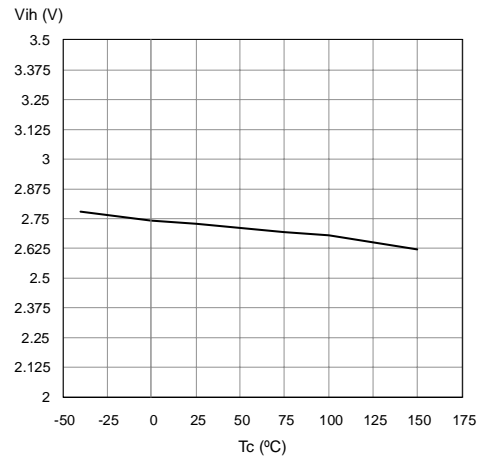
On State Resistance Vs V_{CC}



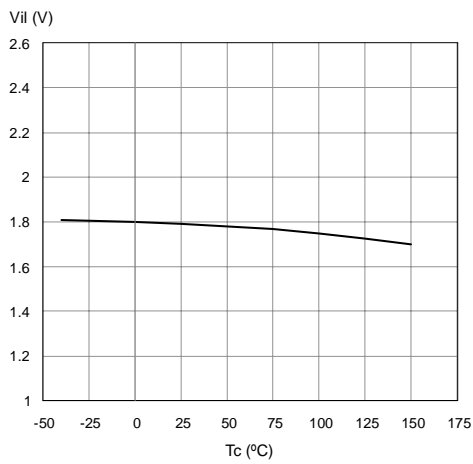
Openload On State Detection Threshold



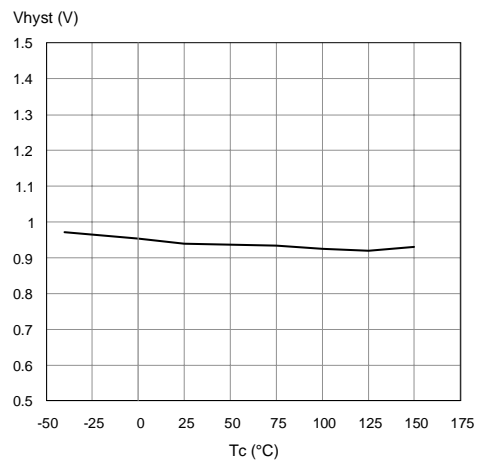
Input High Level



Input Low Level

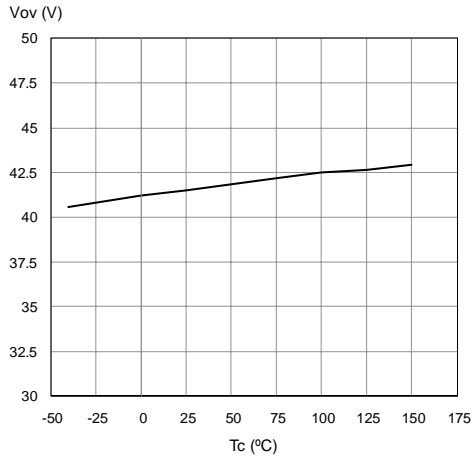


Input Hysteresis Voltage

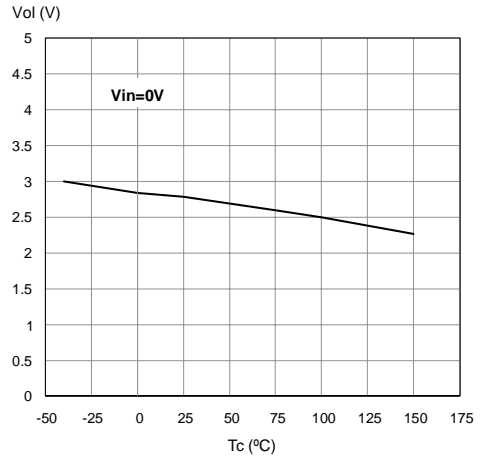


ELECTRICAL CHARACTERIZATION FOR DUAL HIGH SIDE SWITCH (continued)

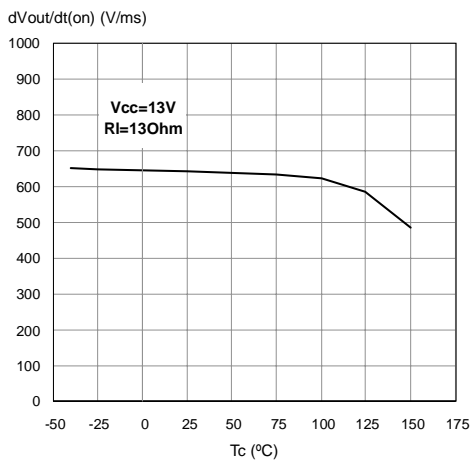
Overvoltage Shutdown



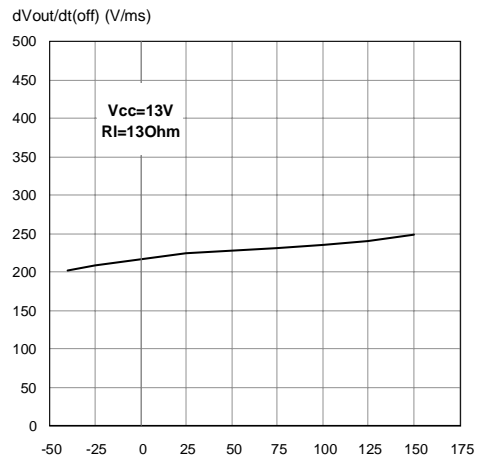
Openload Off State Voltage Detection Threshold



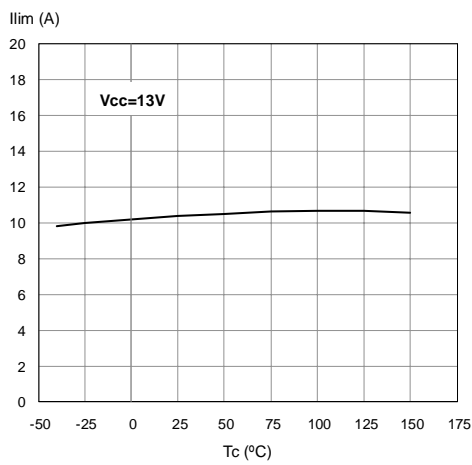
Turn-on Voltage Slope



Turn-off Voltage Slope

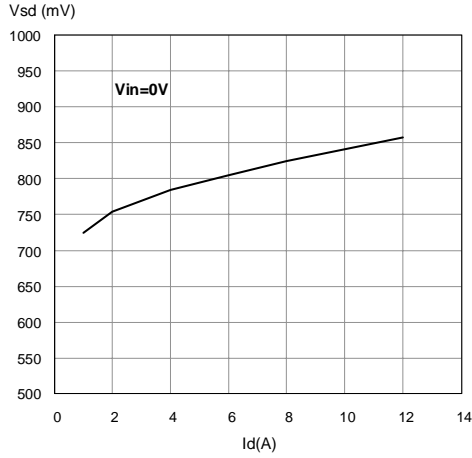


I_{LIM} Vs T_{case}

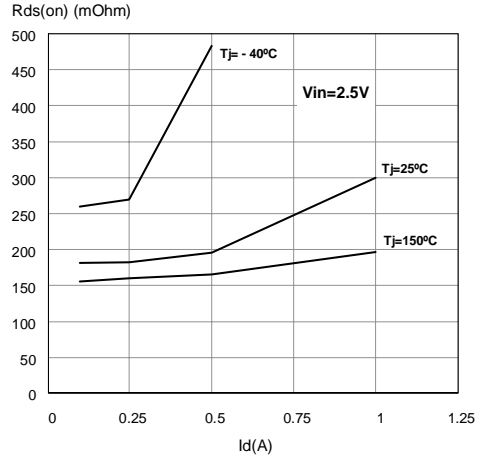


ELECTRICAL CHARACTERIZATION FOR LOW SIDE SWITCHES

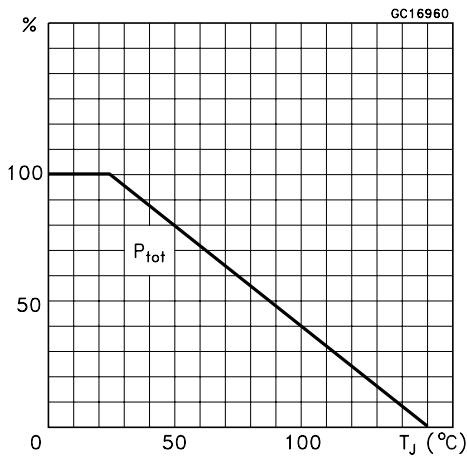
Source-Drain Diode Forward Characteristics



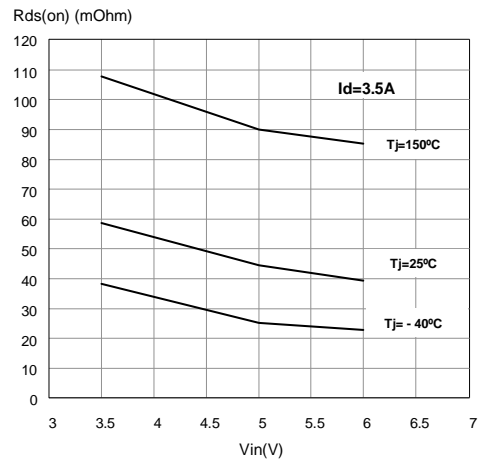
Static Drain Source On Resistance



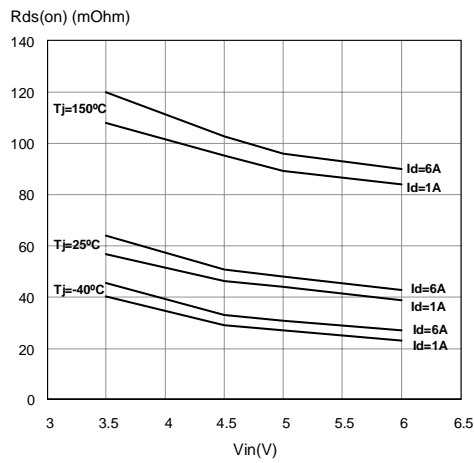
Derating Curve



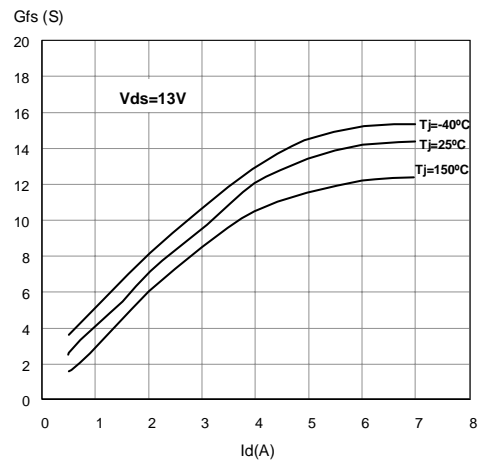
Static Drain-Source On resistance Vs. Input Voltage



Static Drain-Source On resistance Vs. Input Voltage

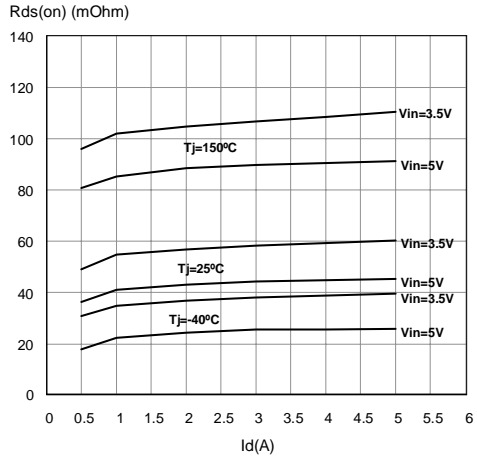


Transconductance

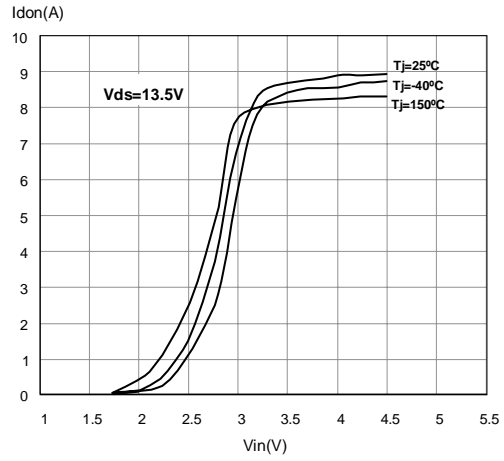


ELECTRICAL CHARACTERIZATION FOR LOW SIDE SWITCHES (continued)

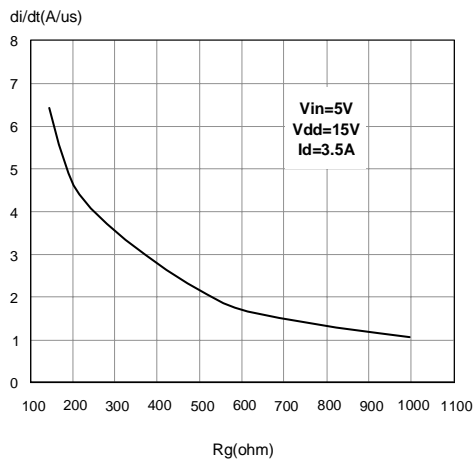
Static Drain-Source On Resistance Vs. Id



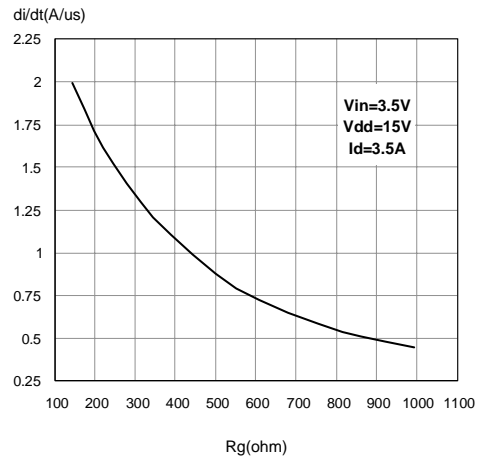
Transfer Characteristics



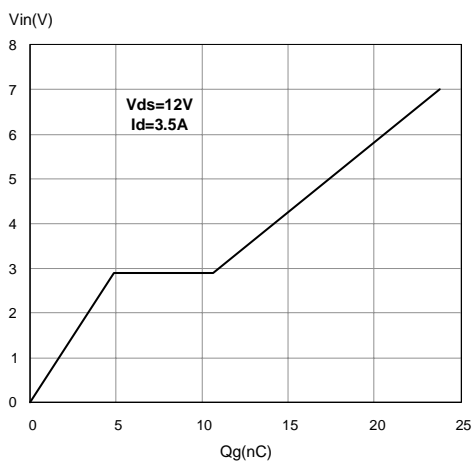
Turn On Current Slope



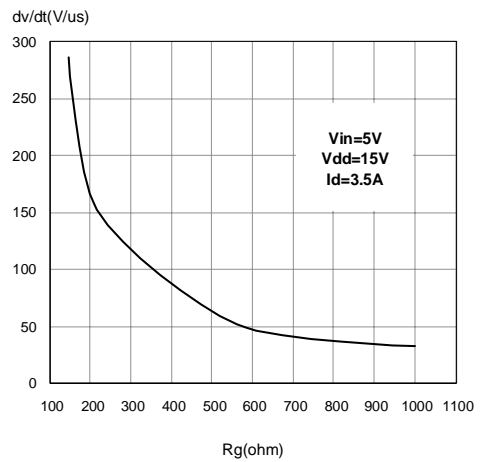
Turn On Current Slope



Input Voltage Vs. Input Charge

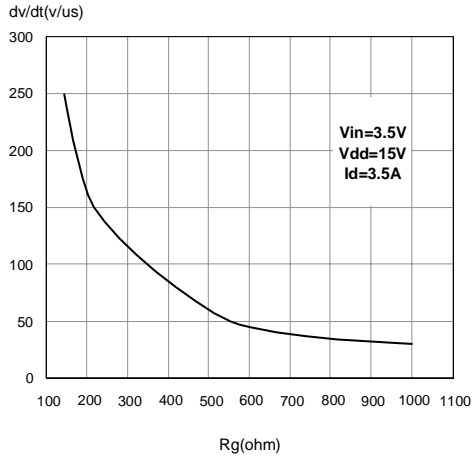


Turn off drain source voltage slope

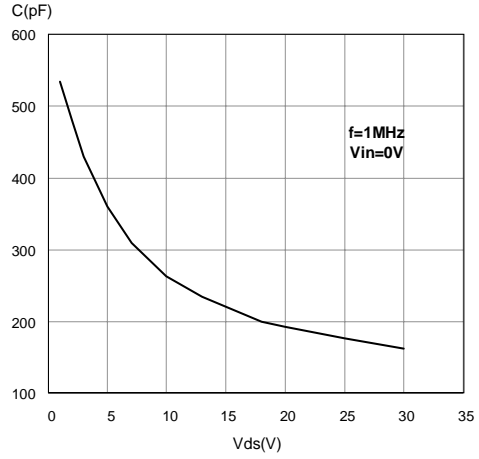


ELECTRICAL CHARACTERIZATION FOR LOW SIDE SWITCHES (continued)

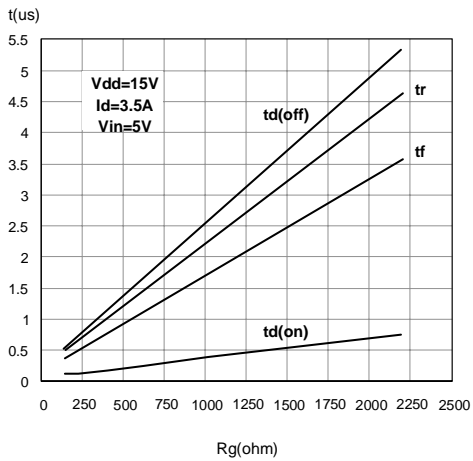
Turn Off Drain-Source Voltage Slope



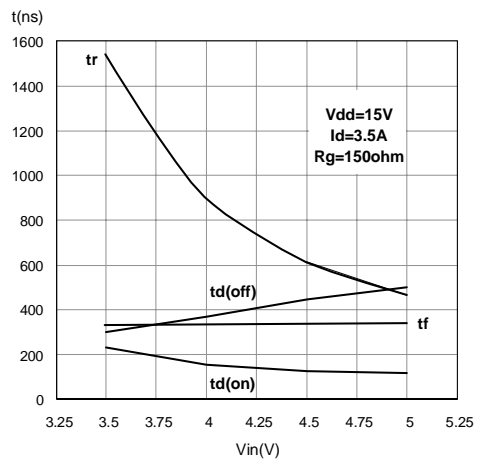
Capacitance Variations



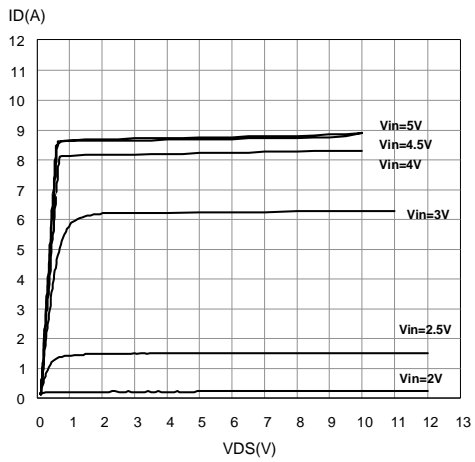
Switching Time Resistive Load



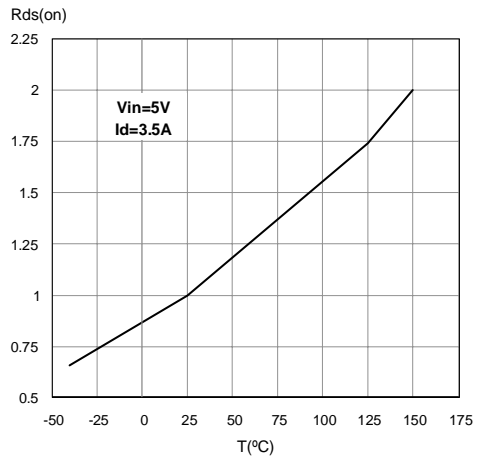
Switching Time Resistive Load



Output Characteristics

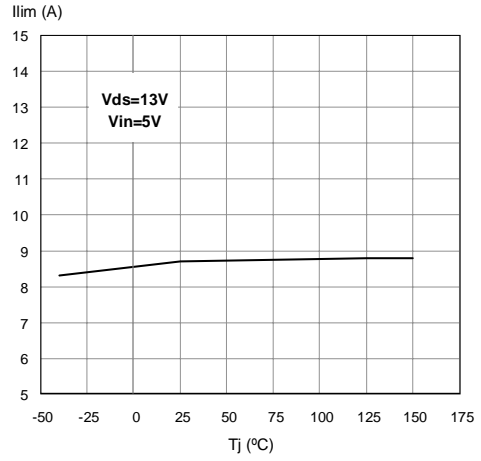
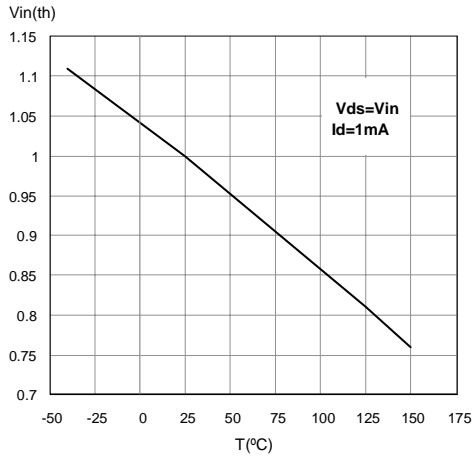


Normalized On Resistance Vs. Temperature

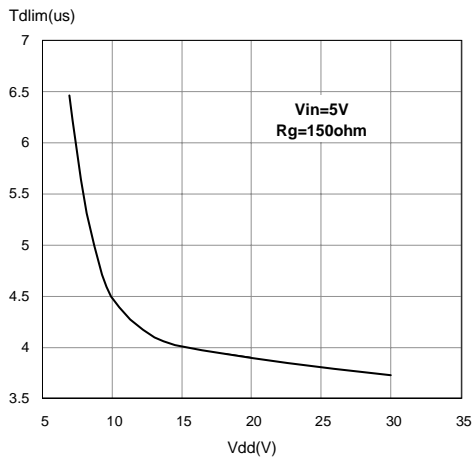


ELECTRICAL CHARACTERIZATION FOR LOW SIDE SWITCHES (continued)

Normalized Input Threshold Voltage Vs. Current Limit Vs. Junction Temperature

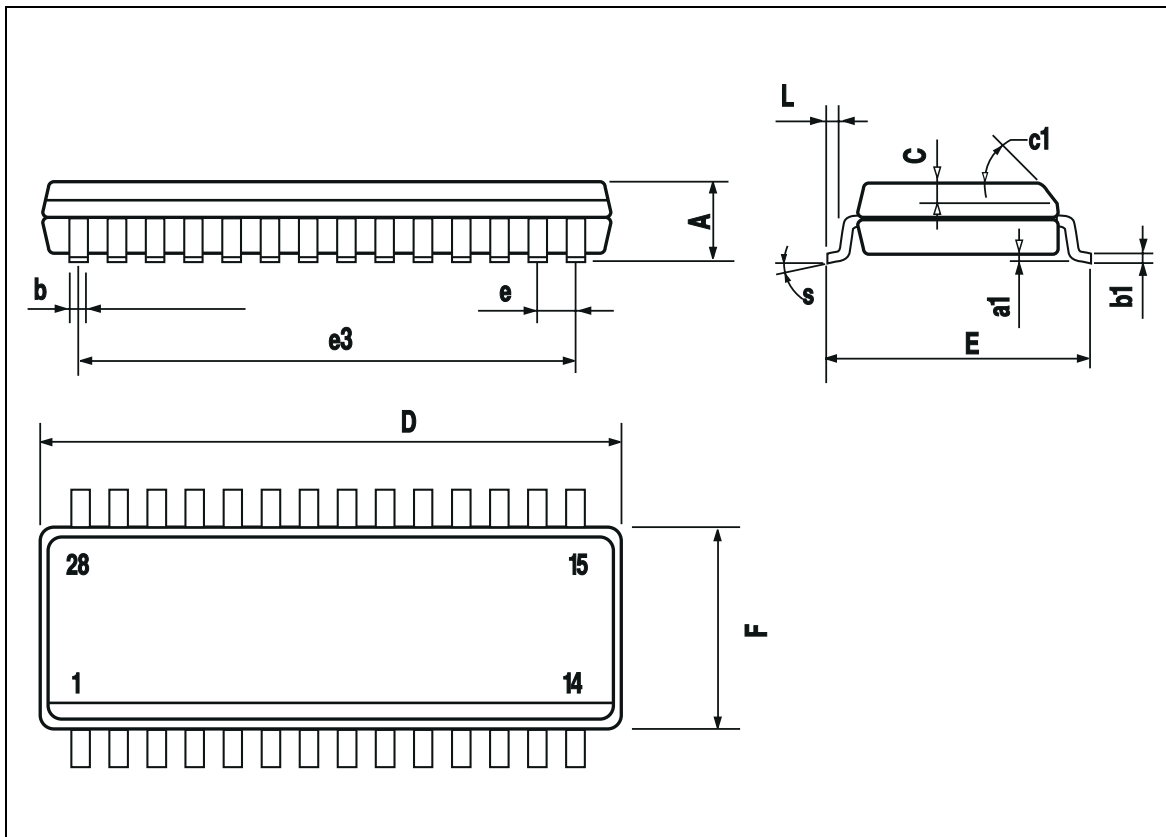


Step Response Current Limit

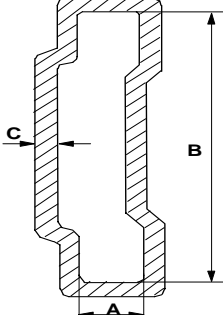


SO-28 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			2.65			0.104
a1	0.10		0.30	0.004		0.012
b	0.35		0.49	0.013		0.019
b1	0.23		0.32	0.009		0.012
C		0.50			0.020	
c1	45 (typ.)					
D	17.7		18.1	0.697		0.713
E	10.00		10.65	0.393		0.419
e		1.27			0.050	
e3		16.51			0.650	
F	7.40		7.60	0.291		0.299
L	0.40		1.27	0.016		0.050
S	8 (max.)					



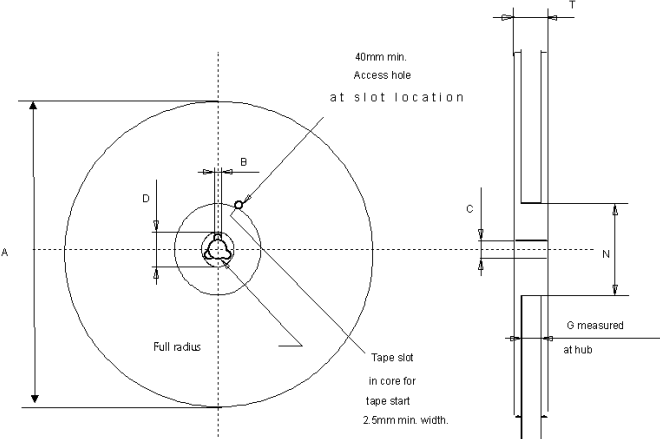
SO-28 TUBE SHIPMENT (no suffix)



Base Q.ty	28
Bulk Q.ty	700
Tube length (± 0.5)	532
A	3.5
B	13.8
C (± 0.1)	0.6

All dimensions are in mm.

TAPE AND REEL SHIPMENT (suffix "13TR")

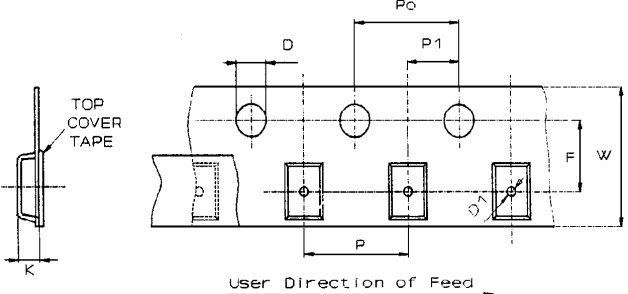


Base Q.ty	1000
Bulk Q.ty	1000
A (max)	330
B (min)	1.5
C (± 0.2)	13
F	20.2
G (+ 2 / - 0)	16.4
N (min)	60
T (max)	22.4

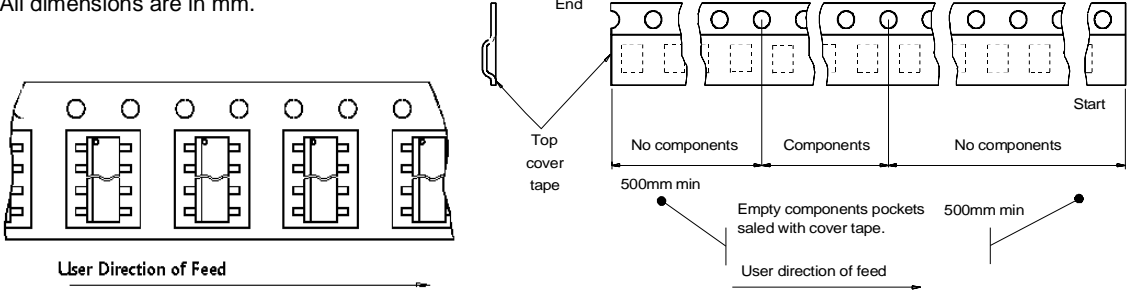
TAPE DIMENSIONS

According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb 1986

Tape width	W	16
Tape Hole Spacing	P0 (± 0.1)	4
Component Spacing	P	12
Hole Diameter	D ($\pm 0.1/-0$)	1.5
Hole Diameter	D1 (min)	1.5
Hole Position	F (± 0.05)	7.5
Compartment Depth	K (max)	6.5
Hole Spacing	P1 (± 0.1)	2



All dimensions are in mm.



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